



#### P-CHANNEL ENHANCEMENT MODE MOSFET

#### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max T <sub>C</sub> = +25°C
-20V	$16m\Omega @ V_{GS} = -4.5V$	-18A
-20V	$22m\Omega$ @ $V_{GS} = -2.5V$	-15A

## **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- **Battery Management Application**
- **Power Management Functions**
- **DC-DC Converters**

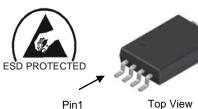
## **Features and Benefits**

- Low Gate Threshold Voltage
- Low On-Resistance
- **ESD Protected Gate**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMP2021UTSQ)

#### **Mechanical Data**

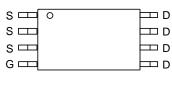
- Case: TSSOP-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Lead Frame. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.039 grams (Approximate)

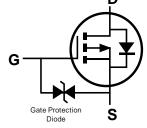












Pin Out **Equivalent Circuit** 

### Ordering Information (Note 4)

Part Number	Case	Packaging
DMP2021UTS-13	TSSOP-8	2,500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



) | = Manufacturer's Marking P2021U = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 17 = 2017)WW = Week (01 to 53)



# 

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	$V_{DSS}$	-20	V		
Gate-Source Voltage	$V_{GSS}$	±10	V		
Continuous Drain Correct (Note C) V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	-7.4 -5.9	А
Continuous Drain Current (Note 6) V <sub>GS</sub> = -4.5V	Steady State	$T_C = +25$ °C $T_C = +70$ °C	I <sub>D</sub>	-18 -14	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	-55	А		
Continuous Source-Drain Diode Current (Note 6) T <sub>A</sub> = +25°C			Is	-2	Α
Pulsed Source-Drain Diode Current (10µs Pulse, Dut	I <sub>SM</sub>	-20	А		
Avalanche Current (Note 7) L = 0.1mH			I <sub>AS</sub>	-25	Α
Avalanche Energy (Note 7) L = 0.1mH	E <sub>AS</sub>	32	mJ		

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	$P_{D}$	0.9	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	146	°C/W
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	P <sub>D</sub>	1.3	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{\theta JA}$	95	°C/W
Thermal Resistance, Junction to Case (Note 6)  Steady Sta		$R_{\theta JC}$	16	C/VV
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C	

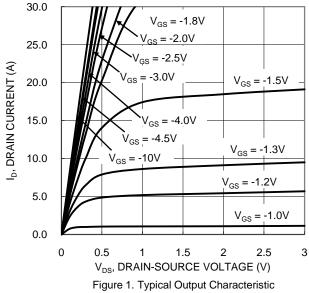
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-20	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	I <sub>DSS</sub>	_	_	-1	μΑ	$V_{DS} = -20V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 8V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)						•	
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.35	_	-1.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
		_	12	16	mΩ	$V_{GS} = -4.5V, I_D = -4.5A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>		15	22		$V_{GS} = -2.5V, I_D = -4.5A$	
			19	40		$V_{GS} = -1.8V, I_D = -2.5A$	
Diode Forward Voltage	V <sub>SD</sub>	_	-0.8	-1.2	V	$V_{GS} = 0V, I_S = -1.0A$	
DYNAMIC CHARACTERISTICS (Note 9)						•	
Input Capacitance	C <sub>iss</sub>	_	2,760	_		$V_{DS} = -15V, V_{GS} = 0V,$ f = 1.0MHz	
Output Capacitance	Coss	_	262	_	pF		
Reverse Transfer Capacitance	C <sub>rss</sub>	_	220	_			
Gate Resistance	Rq	_	16	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Qg	_	34	_			
Total Gate Charge (V <sub>GS</sub> = -8V)	Qq	_	59	_		$V_{DS} = -15V, I_{D} = -4.0A$	
Gate-Source Charge	Q <sub>qs</sub>	_	3.5	_	nC		
Gate-Drain Charge	Q <sub>gd</sub>		8.3	_			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	7.5	_		V <sub>DS</sub> = -15V, V <sub>GS</sub> = -4.5V,	
Turn-On Rise Time	t <sub>R</sub>		25	_			
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	125	_	ns	$R_G = 1\Omega$ , $I_D = -4.0A$	
Turn-Off Fall Time	t <sub>F</sub>		96	_			
Reverse Recovery Time	t <sub>RR</sub>	_	48	_	ns	I <sub>F</sub> = -1.0A, di/dt = 100A/μs	
Reverse Recovery Charge	Q <sub>RR</sub>		33	_	nC	$I_F = -1.0A$ , $di/dt = 100A/\mu s$	

Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
- 7.  $I_{AS}$  and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J$  = +25°C.
- 8. Short duration pulse test used to minimize self-heating effect.
  9. Guaranteed by design. Not subject to product testing.





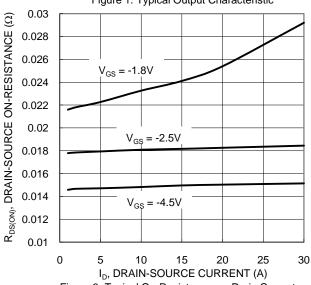


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

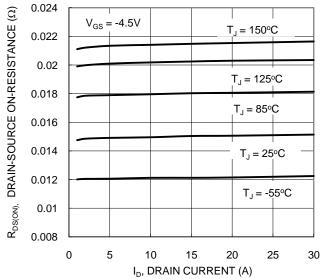


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

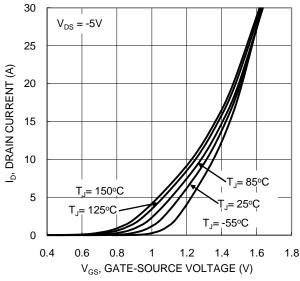
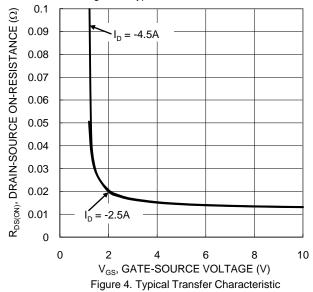


Figure 2. Typical Transfer Characteristic



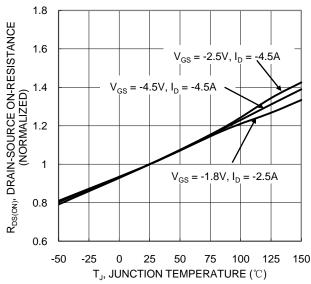


Figure 6. On-Resistance Variation with Junction Temperature



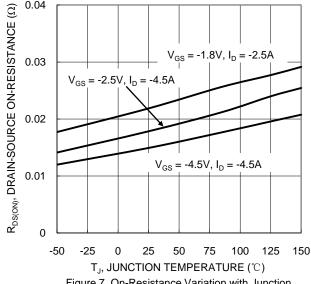


Figure 7. On-Resistance Variation with Junction Temperature

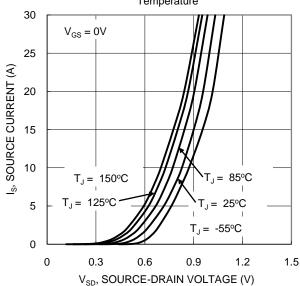
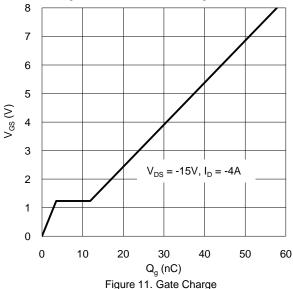


Figure 9. Diode Forward Voltage vs. Current



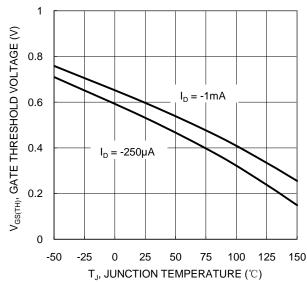


Figure 8. Gate Threshold Variation vs. Junction Temperature

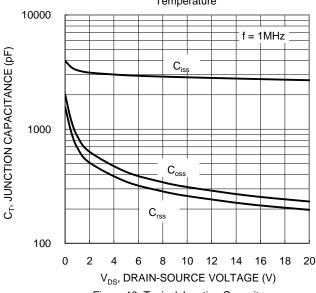
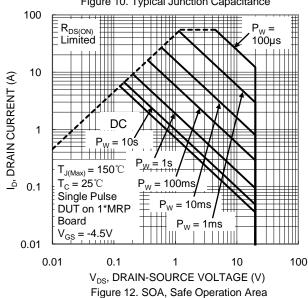


Figure 10. Typical Junction Capacitance



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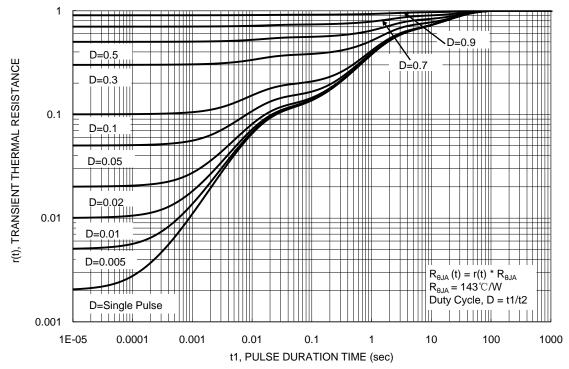


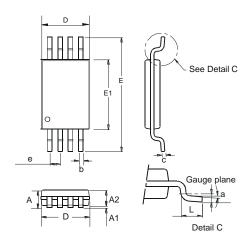
Figure 13. Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### TSSOP-8

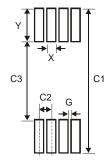


TSSOP-8					
Dim	Min	Max	Тур		
а	0.09	-	-		
Α	-	1.20	-		
A1	0.05	0.15	-		
A2	0.825	1.025	0.925		
b	0.19	0.30	_		
С	0.09	0.20	-		
D	2.90	3.10	3.025		
е	-	_	0.65		
Е	_	_	6.40		
E1	4.30	4.50	4.425		
L	0.45	0.75	0.60		
All Dimensions in mm					

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### TSSOP-8



<b>Dimensions</b>	Value (in mm)			
Х	0.45			
Υ	1.78			
C1	7.72			
C2	0.65			
C3	4.16			
G	0.20			



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